

SOT23-6L Plastic-Encapsulate ESD Protection Diodes

Features

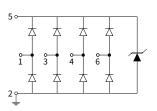
- · Low leakage current
- SOT-23-6L surface mount package
- IEC 61000-4-2 (ESD Air): ±15kV
- IEC 61000-4-2 (ESD Contact): ±15kV
- IEC 61000-4-5 (Lightning 8/20μs): 4A

Applications

- Automotive Applications
- CAN Bus
- Electronic Control Units
- Body Control Units
- · ADAS Control Units
- Power Train Control Units

Function Diagram





Reverse Working Voltage 5.0V Max. Ultra small capacitance C_{I/O-GND}=1.0pF(Typ.) C_{I/O-I/O}=0.5pF(Typ.)

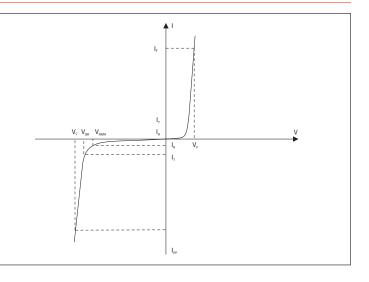


Maximum Ratings (Ta=25°C Unless otherwise specified)

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
V _{ESD} Electrostatic Discharge Voltage I P _{PP} Peak Pulse Power 1		ESD per IEC 61000-4-2(Air)	±15	KV
		ESD per IEC 61000-4-2(Contact)	±15	KV
		tp = 8/20 μs	80	W
		tp = 8/20 μs	4.0	А
		_	-55 to +125	°C
T _{STG}	Operating JunctionTemperature Range	_	-55 to +150	°C

Electrical Parameter

SYMBOL	PARAMETER	
V _c	Clamping Voltage @ I _{PP}	
V _{BR}	Breakdown Voltage @ I _T	
I _{PP}	Peak Pulse Current	
I _T	Test Current	
I _R	Reverse Leakage Current @ VRWM	
V _{RWM}	Peak Reverse Working Voltage	
P _{PP}	Peak Pulse Power Dissipation	
C _J Junction Capacitance @ V _R =0V,f=1MHz		
I _F	Forward Current	
V _F	Forward Voltage @I _F	

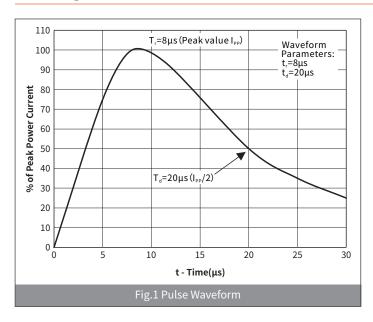


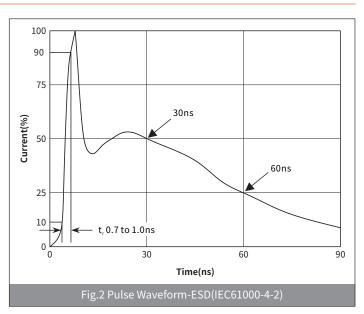


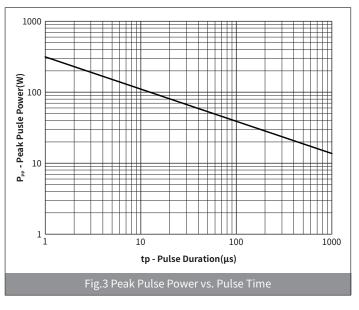
Electrical Characteristics (Ta=25°C Unless otherwise specified)

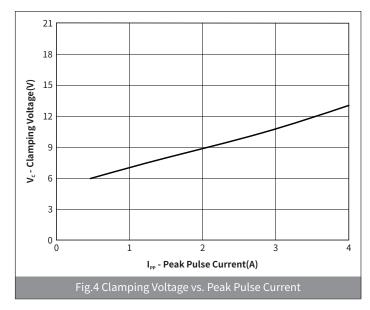
PARAMETER	SYMBOL	CONDITION	Min	Тур	Max	UNIT
Peak Reverse Working Voltage	V _{RWM}	T _a =25°C	_	_	5.0	V
Breakdown Voltage	V _{BR}	I _R =1mA,T _a =25°C	6.0	_	_	V
Reverse Leakage Current	I _R	V _{RWM} =5.0V,T _a =25°C	_	_	5.0	μΑ
Forward voltage	V _F	I _F =10mA,T _a =25°C	_	0.8	1.0	V
Clamping Voltage	V _c	I _{pp} =4.0A, t _p =8/20μs	_	12	15	V
lunction Canacitance		V _{RMW} =0V,f=1MHz,Between I/O pins	_	0.5	_	nГ
Junction Capacitance	C _J	V _{RMW} =0V,f=1MHz,pin to GND	_	1.0	_	pF

• Ratings And Characteristics Curves (Ta=25°C Unless otherwise specified)







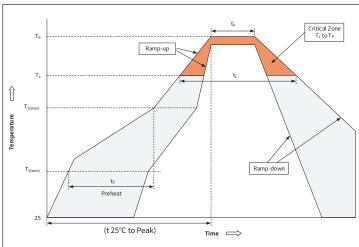




Ordering Information

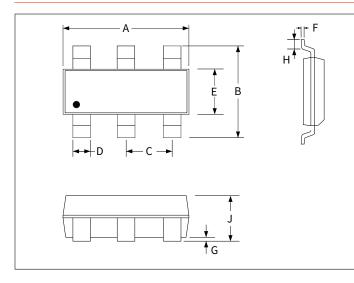
PACKAGE	PACKAGE CODE	UNIT WEIGHT(g)	REEL(pcs)	BOX(pcs)	CARTON(pcs)	DELIVERY MODE
SOT-23-6L	R1	0.008	3000	30000	120000	7''

Recommended Soldering Conditions



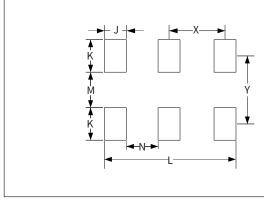
		Profile Feature	Pb-Free Assembly	
		Temperature Min (T _{S(min)})	+150°C	
Pre-h	re-heat	Temperature Max(T _{S(max)})	+200°C	
		Time (Min to Max) (t _s)	60-180 secs.	
Avera	ige ramp up r	rate (Liquid us Temp (T _L) to peak)	3°C /sec. Max	
T _{S(max)}	to T _L - Ramp	-up Rate	3°C /sec. Max	
Poflo	Reflow	Temperature(T _L)(Liquid us)	+217°C	
Relio		Temperature(t _L)	60-150 secs.	
Peak	Temp (T _P)		+260(+0/-5)°C	
Time	within 5°C of	factual Peak Temp (t _P)	20-40secs	
Ramp-down Rate			6°C /sec. Max	
Time	ne 25°C to Peak Temp (T _P)		8 min. Max	
Do not exceed			+260°C	

• Package Outline Dimensions (SOT23-6L)



		Dimei	mensions			
Symbol	Millimeters		Inches			
	Min.	Max.	Min.	Max.		
А	2.80	3.00	0.110	0.118		
В	2.60	3.00	0.102	0.118		
С	0.93	0.97	0.037	0.038		
D	0.41		0.016			
E	1.50	1.70	0.059	0.067		
F	0.11	0.19	0.004	0.007		
G	-	0.10	-	0.004		
Н	0.40	-	0.016	-		
J	1.00	1.20	0.035	0.057		

Suggested Pad Layout



		Dilliei	1510115	
Symbol	Millin	neters	Inches	
	Min.	Max.	Min.	Max.
J	0.60	-	0.024	-
K	0.90	-	0.035	-
М	-	1.40	-	0.055
N	-	0.35	-	0.014
X	-	0.95	-	0.037
Υ	-	2.30	-	0.090
L	-	2.50	-	0.098

Note:

This soldering footprint is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.